

PATENT ASSIGNMENT

Electronic Version v1.1
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SUBMISSION TYPE:	NEW ASSIGNMENT								
NATURE OF CONVEYANCE:	ASSIGNMENT								
CONVEYING PARTY DATA									
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:70%;">Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Shijun Li</td> <td>11/27/2007</td> </tr> <tr> <td>Yongli Jia</td> <td>11/27/2007</td> </tr> <tr> <td>Lijun Pu</td> <td>11/27/2007</td> </tr> </tbody> </table>		Name	Execution Date	Shijun Li	11/27/2007	Yongli Jia	11/27/2007	Lijun Pu	11/27/2007
Name	Execution Date								
Shijun Li	11/27/2007								
Yongli Jia	11/27/2007								
Lijun Pu	11/27/2007								
RECEIVING PARTY DATA									
Name:	Huawei Technologies Co., Ltd.								
Street Address:	Huawei Administration Building								
Internal Address:	Bantian, Longgang District								
City:	Shenzhen, Guangdong								
State/Country:	CHINA								
Postal Code:	518129								
PROPERTY NUMBERS Total: 1									
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:30%;">Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>11969004</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	11969004				
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Application Number:	11969004								
CORRESPONDENCE DATA									
Fax Number:	(312)616-5700								
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>									
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Address Line 2:	180 NORTH STETSON AVENUE								
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ATTORNEY DOCKET NUMBER:	702411								
NAME OF SUBMITTER:	John B. Conklin								
Total Attachments: 2									

CH \$40.00 11969004

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**PATENT
 REEL: 020313 FRAME: 0823**

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Leydig, Voit & Mayer, Ltd.
Two Prudential Plaza, Suite 4900
180 North Stetson Avenue
Chicago, Illinois 60601-6731

ASSIGNMENT

WHEREAS, WE,

Shijun LI
Huawei Administration Building
Bantian, Longgang District
Shenzhen 518129, Guangdong
P. R. CHINA; and

Yongli JIA
Huawei Administration Building
Bantian, Longgang District
Shenzhen 518129, Guangdong
P. R. CHINA; and

Lijun PU
Huawei Administration Building
Bantian, Longgang District
Shenzhen 518129, Guangdong
P. R. CHINA

have invented and own a certain invention entitled:

METHOD FOR INTER-SYSTEM HANDOVER

for which invention we have executed an application (provisional or non-provisional) for a U.S. patent, which was filed on _____, under U.S. Application No. _____, and

WHEREAS, HUAWEI TECHNOLOGIES CO., LTD., of Huawei Administration Building, Bantian, Longgang District, Shenzhen 518129, Guangdong P. R. China, hereinafter referred to as Assignee, is desirous of acquiring the entire domestic and foreign right, title, and interest in and under the invention described in the patent application.

NOW, THEREFORE, for good and valuable considerations, the receipt and sufficiency of which are hereby acknowledged, we assign and transfer to the Assignee and the Assignee's legal representatives, successors and assigns the full and exclusive rights in and to the invention in the U.S. and every foreign country and the entire right, title, and interest in and to the patent application and other such applications (e.g., provisional applications, non-provisional applications, continuations, continuations-in-part, divisionals, reissues, reexaminations, National phase applications, including petty patent applications, and utility model applications) that may be filed in the United States and every foreign country on the invention, and the patents, extensions, or derivations thereof, both foreign and domestic, that may issue thereon, and we do hereby authorize and request the Commissioner of Patents to issue U.S. patents to the above-mentioned Assignee agreeably with the terms of this assignment document.

WE HEREBY AUTHORIZE the Assignee to insert in this assignment document the filing date and application number of the application if the date and number are unavailable at the time this document is executed.

In re Appln. of
Attorney Docket No.

WE DO HEREBY COVENANT and agree with the Assignee that we will not execute any writing or do any act whatsoever conflicting with the terms of this assignment document set forth herein, and that we will at any time upon request, without further or additional consideration, but at the expense of the Assignee, execute such additional assignments and other writings and do such additional acts as the Assignee may deem necessary or desirable to perfect the Assignee's enjoyment of this assignment, and render all necessary assistance in making application for and obtaining original, continuation, continuation-in-part, divisional, reissued, reexamined, and National phase patents of the U.S. or of any and all foreign countries on the invention, and in enforcing any rights or choses in action accruing as a result of such applications or patents, and by executing statements and other affidavits, it being understood that the foregoing covenant and agreement shall bind, and inure to the benefit of, the assigns and legal representatives of all parties hereto.

IN WITNESS WHEREOF, we have hereunder set our hands on the dates shown below.

Date 2007.11.27 Shi Jun Li
Shijun LI
Date 2007.11.27 Xuehong Wang
Witness
Date 2007.11.27 Miao Yu
Witness

Date 2007.11.27 Yongli JIA
Yongli JIA
Date 2007.11.27 Xuehong Wang
Witness
Date 2007.11.27 Yongli Ren
Witness

Date 2007.11.27 Lijun PU
Lijun PU
Date 2007.11.27 Miao Yu
Witness
Date 2007.11.27 Yongli Ren